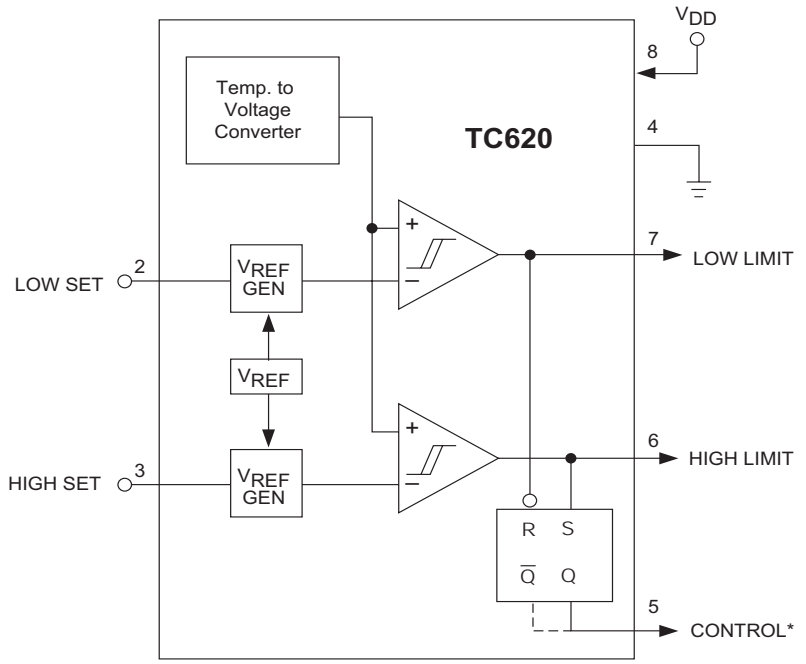
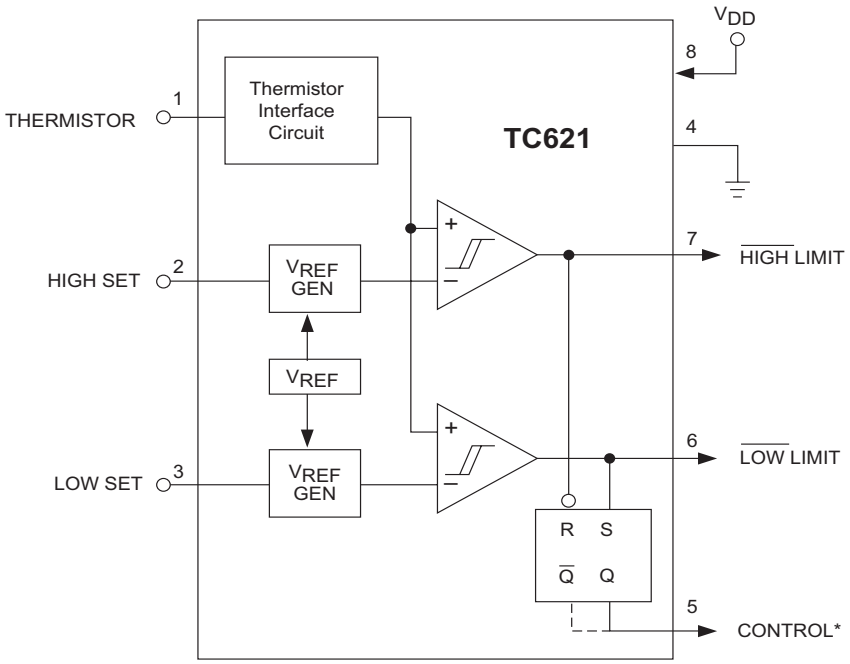
Functional Block Diagrams





*Suffix code "C" denotes cooling option (High true CONTROL output).
Suffix code "H" denotes heating option (Low true CONTROL output).

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

Supply Voltage 20V

Input Voltage Any Input .. (GND – 0.3V) to (V_{DD} +0.3V)

Package Power Dissipation ($T_A \leq 70°C$)

PDIP ..... 730 mW

SOIC ..... 470 mW

Derating Factors:

Plastic ..... 8 mW/°C

Operating Temperature:

M Version ..... -55°C to +125°C

V Version ..... -40°C to +125°C

E Version ..... -40°C to +85°C

C Version ..... 0°C to +70°C

Storage Temperature ..... -65°C to +150°C

*Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC620/TC621 ELECTRICAL SPECIFICATIONS

Electrical Characteristics: T_A = 25°C, unless otherwise specified.

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{DD}	Supply Voltage Range	4.5	—	18	V	
I_{DD}	Supply Current	—	270	400	µA	$5V \leq V_{DD} \leq 18V$
R_{OUT}	Output Resistance	—	400	1000	W	Output High or Low, $5V \leq V_{DD} \leq 18V$
I_{OUT}	Output Current	—	—	1	mA	Temp. Sensed Source/Sink
I_{OUT}	Output Current	—	—	1	mA	Cool/Heat Source/Sink
T_{ERR}	Absolute Accuracy	T - 3	T	T + 3	°C	T = Programmed Temperature

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

TABLE 2-1: PIN FUNCTION TABLE

Pin No. (8-Pin PDIP) (8-Pin SOIC) 0°C to +70°C -40°C to +85°C -40°C to +125°C	Symbol	Description
1	NC	No Internal Connection.
2	LOW SET	Low temperature set point. Connect an external 1% resistor from LOW SET to V_{DD} to set trip point.
3	HIGH SET	High temperature set point. Connect an external 1% resistor from HIGH SET to V_{DD} to set trip point.
4	GND	Ground Terminal.
5	CONTROL	Control output.
6	HIGH LIMIT	High temperature push/pull output.
7	LOW LIMIT	Low temperature push/pull output.
8	V_{DD}	Power supply input.

Pin No. (8-Pin PDIP) (8-Pin SOIC) 0°C to +70°C -40°C to +85°C	Symbol	Description
1	THERMISTOR	Thermistor input.
2	HIGH SET	High temperature set point. Connect an external 1% resistor from HIGH SET to V_{DD} to set trip point.
3	LOW SET	Low temperature set point. Connect an external 1% resistor from LOW SET to V_{DD} to set trip point.
4	GND	Ground Terminal.
5	CONTROL	Control output.
6	$\overline{\text{LOW}}$ LIMIT	Low temperature push/pull output.
7	$\overline{\text{HIGH}}$ LIMIT	High temperature push/pull output.
8	V_{DD}	Power supply input.

3.0 DETAILED DESCRIPTION

The TC620 has a positive temperature coefficient temperature sensor and a dual threshold detector. Temperature set point programming is accomplished with external resistors from the HIGH SET and LOW SET inputs to $V_{DD.}$ The HIGH LIMIT and LOW LIMIT outputs remain low as long as measured temperature is below set point values. As measured temperature increases, the LOW LIMIT output is driven high when temperature equals the LOW SET set point (±3°C max). If temperature continues to climb, the HIGH LIMIT output is driven high when temperature equals the HIGH SET set point (Figure 3-1). The CONTROL (hysteresis) output is latched in its active state at the temperature specified by the HIGH SET resistor. CONTROL is maintained active until temperature falls to the value specified by the LOW SET resistor.

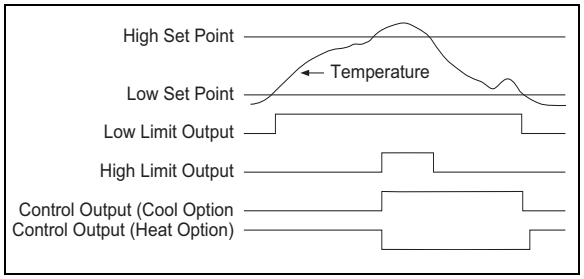


FIGURE 3-1: *TC620/TC621 Input vs. Output Logic*

3.1 Programming the TC620

The resistor values to achieve the desired trip point temperatures on HIGH SET and LOW SET are calculated using Equation 3-1:

EQUATION 3-1:

$$R_{TRIP} = 0.5997 \text{ x } T^{2.1312}$$

Where:

R_{TRIP} = Programming resistor in Ohms
T = The desired trip point temperature in degrees Kelvin.

For example, a 50°C setting on either the HIGH SET or LOW SET input is calculated using Equation 3-2 as follows:

EQUATION 3-2:

$$R_{SET} = 0.5997 \text{ x } ((50 + 273.15)^{2.1312}) = 133.6 \text{ k}\Omega$$

Care must be taken to ensure the LOW SET programming resistor is a smaller value than the HIGH SET programming resistor. Failure to do this will result in erroneous operation of the CONTROL output.

Care must also be taken to ensure the LOW SET temperature setting is at least 5°C lower than the HIGH SET temperature setting.

Figure 3-2 can help the user obtain an estimate of the external resistor values required for the desired LOW SET and HIGH SET trip points.

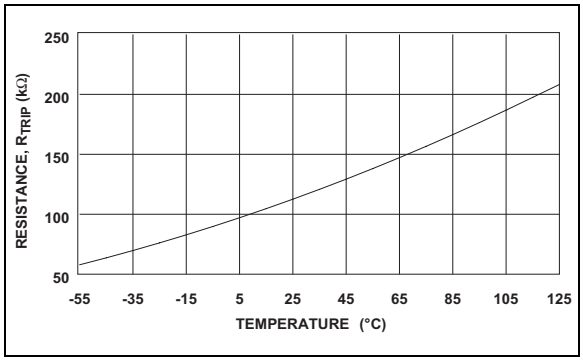


FIGURE 3-2: *TC620 Sense Resistors vs. Trip Temperature*

3.2 Built-in Hysteresis

To prevent output "chattering" when measured temperature is at (or near) the programmed trip point values, the LOW SET and HIGH SET inputs each have built-in hysteresis of -2°C below the programmed settings (Figure 3-3).

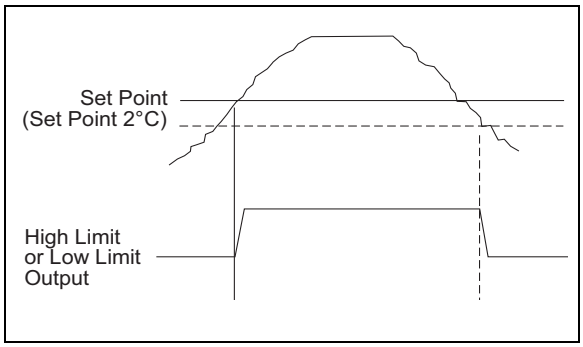


FIGURE 3-3: *Built-In Hysteresis on Low Limit and High Limit Outputs*

As shown, the outputs remain in their active state (hysteresis) until temperature falls an additional 2°C below the user's setting.

3.3 Using the TC621

The TC621 operation is similar to that of the TC620, but requires an external NTC thermistor. Use the resistance versus temperature curve of the thermistor to determine the values of the programming resistors. Note that the pin numbers for the HIGH SET and LOW SET programming resistors for the TC621 are reversed versus that of the TC620 (i.e., the resistor value on HIGH SET [Pin 2] should always be lower than the one connected to LOW SET [Pin 3]). Also note that the outputs of the TC621 are LOW TRUE when used with an NTC thermistor.

3.4 TC621 Thermistor Selection

The TC621 uses an external thermistor to monitor the controlling temperature. A thermistor with a resistance value of approximately 100 kΩ at 25°C is recommended.

A temperature set point is selected by picking a resistor whose value is equal to the resistance of the thermistor at the desired temperature. For example, using the data shown in Figure 3-4, a 30 kΩ resistor between HIGH TEMP (Pin 2) and V_{DD} (Pin 8) sets the high temperature trip point at +51°C and a 49 kΩ resistor on LOW TEMP (Pin 3) sets the low temperature trip point to +41°C.

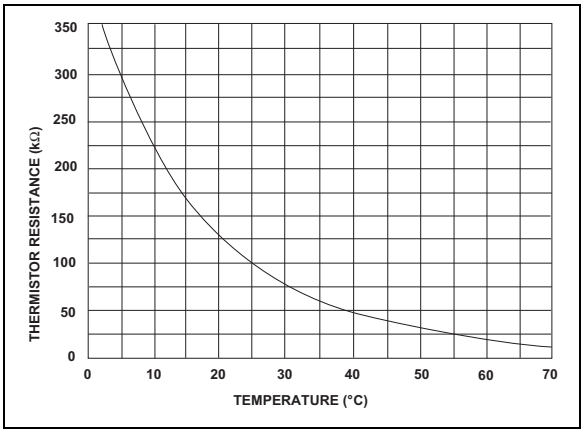


FIGURE 3-4: *Typical NTC Thermistor*

3.5 TC620/TC621 Outputs

Both devices have complimentary output stages. They are rated at a source or sink current of 1 mA maximum.

4.0 TYPICAL APPLICATIONS

4.1 Dual Speed Temperature Control

In Figure 4-1, the Dual Speed Temperature Control uses a TC620 and a TC4469 quad driver. Two of the drivers of the TC4469 are configured in a simple oscillator. When the temperature is below the LOW TEMP set point, the output of the driver is OFF. When the temperature exceeds the LOW TEMP set point, the TC4469 gates the oscillator signal to the outputs of the driver. This square wave signal modulates the remaining outputs and drives the motor at a low speed. If this speed cannot keep the temperature below the HIGH TEMP set point, then the driver turns on continuously which increases the fan speed to high. The TC620 will monitor the temperature and only allow the fan to operate when needed and at the required speed to maintain the desired temperature. A higher power option can be designed by adding a resistor and a power MOSFET.

4.2 Temperature Controlled Fan

In the application in Figure 4-2, a high and a low temperature is selected by two R_L and R_H. The TC620 monitors the ambient temperature and turns the FET switch on when the temperature exceeds the HIGH TEMP set point. The fan remains on until the temperature decreases to the LOW TEMP set point. This provides the hysteresis. In this application, the fan turns on only when required.

The TC621 uses an external thermistor to monitor the ambient temperature. This adds one part, but allows more flexibility with the location of the temperature sensor.

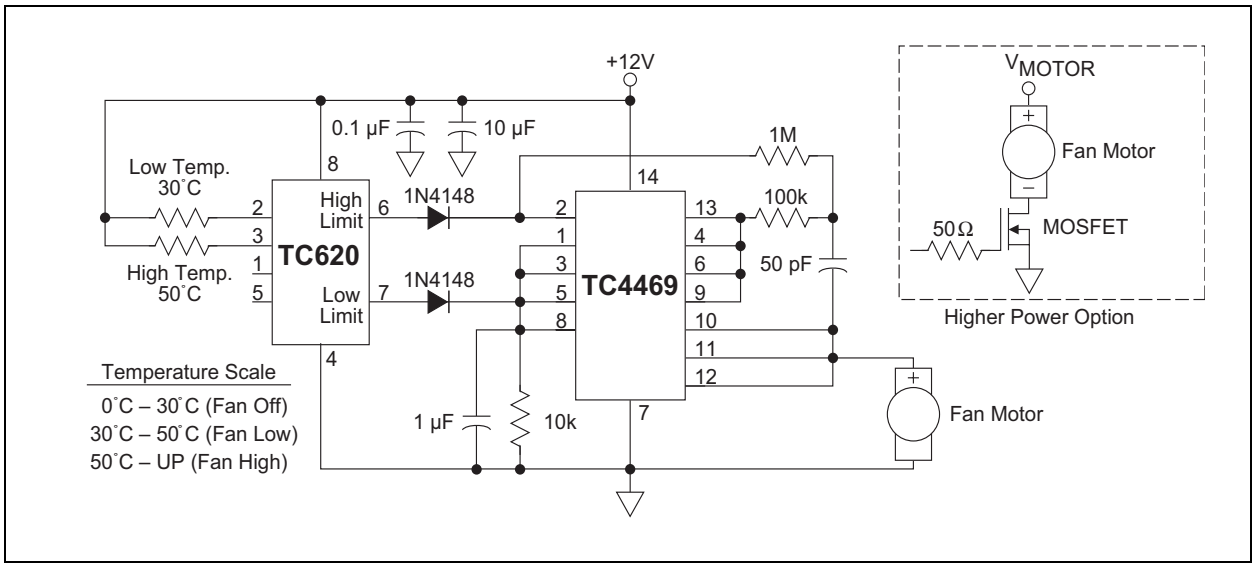


FIGURE 4-1: *Dual Speed Temperature Control*

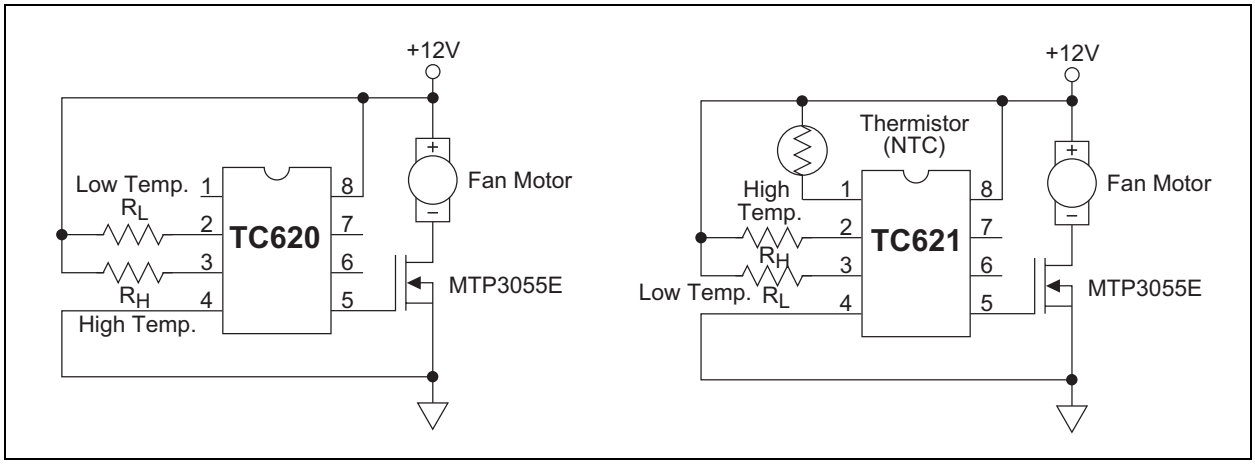


FIGURE 4-2: *Temperature Controlled Fan*

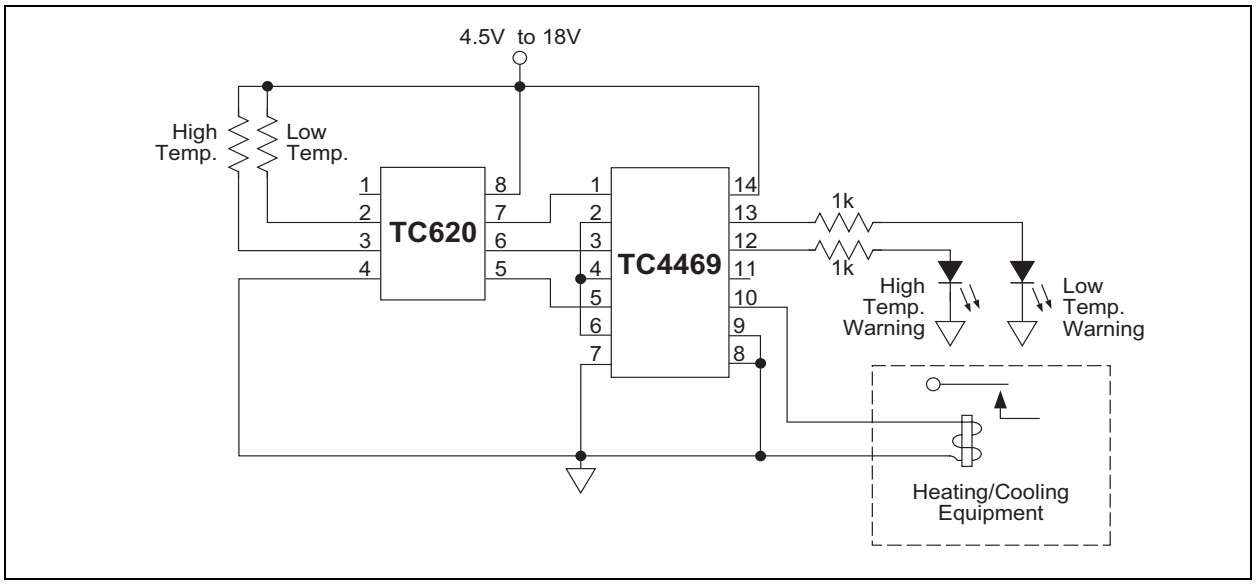


FIGURE 4-3: *Heating and Cooling Application*

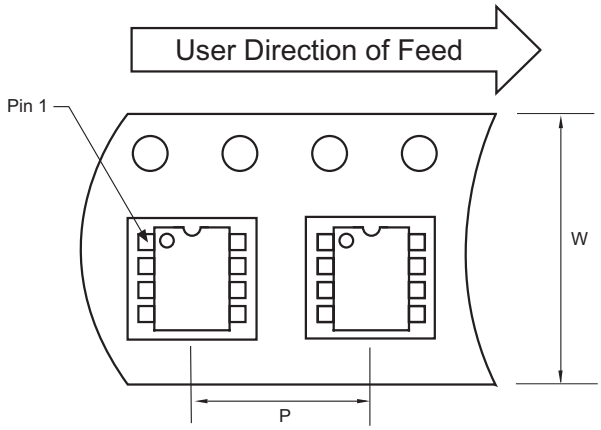
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

Package marking data not available at this time.

5.2 Taping Form

Component Taping Orientation for 8-Pin SOIC (Narrow) Devices



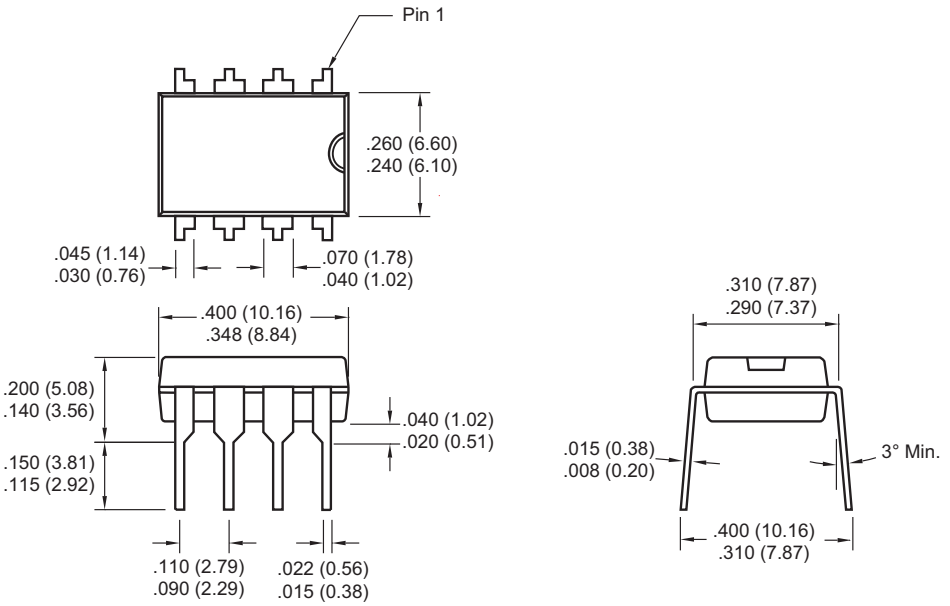
Standard Reel Component Orientation
for 713 Suffix Device

Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin SOIC (N)	12 mm	8 mm	2500	13 in

5.3 Package Dimensions

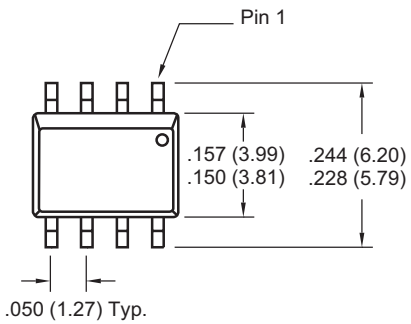
8-Pin Plastic DIP

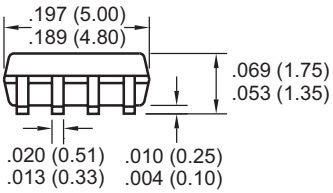


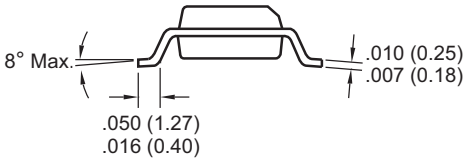
Dimensions: inches (mm)

Package Dimensions (Continued)

8-Pin SOIC







Dimensions: inches (mm)

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